

Quantum thermal transport in carbon nanostructures

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Outline

Motivation

- Method for nanoscale thermal transport: NEGF
- Applications
 - * Nanotube phonon waveguide
 - * Graphene nanoribbons: anisotropy
 - *** Graphene-based nanostructures**
- Summary

Serious heat dissipation



E. Pop, *et al.* Proceedings of the IEEE **94,** 1587 (2006).

Evolution of transistor designs

Thermal insulation

Thermal Barrier Coatings for Gas-Turbine Engine Applications



Distance

N. P. Padture, et al., Science 296, 280 (2002).

Low thermal conductivity Stable at high *T*.

Thermoelectric applications

90% (10 TW) of effective energy is generated by heat engines, accompanying with 15 TW wasted heat.



Refrigerators and power generators

Thermal devices



Thermal diodes, thermal transistor

Applications:

refrigerator, heat dissipation in microelectronic processor, energy saving building, thermal logical gates

Method: nanoscale thermal transport

Traditional methods fail at nanoscale. <u>Molecular dynamics:</u>

classical, breakdown at low T, definition of T?

Boltzmann-Peierls equation:

concept of distribution function?

New methods are urgently needed. Landauer formula:

simple physical picture for mesoscopic transport Nonequilibrium Green's function (NEGF): fully based on quantum mechanics, general.

First-principles based NEGF method

Features:

- Atomic scale simulation
- Quantum effects
- No empirical parameters
- For realistic materials, nanodevices

Code Programming:

- FORTRAN language
- Interface with widely used softwares (VASP, SIESTA etc.)
- Semi-empirical model for faster calculations

First-principles based NEGF method

Total Hamiltonian:

$$H = \sum_{\alpha = L, C, R} H_{\alpha} + V + H_n$$

Harmonic Hamiltonian:

$$H_{\alpha} = \frac{1}{2} (\dot{u}_{\alpha})^T \dot{u}_{\alpha} + \frac{1}{2} u_{\alpha}^T D_{\alpha \alpha} u_{\alpha} \quad (\alpha = L, C, R)$$
$$V = (u_L)^T D_{LC} u_C + (u_C)^T D_{CR} u_R$$

$$u_{\alpha} = (u_1^{\alpha}, u_2^{\alpha}, u_3^{\alpha}, \cdots)^T$$
, $u_i^{\alpha} = \sqrt{M_i^{\alpha}} x_i^{\alpha}$



Force Constants: $[D_{\alpha\beta}]_{ij} = D_{ij}^{\alpha\beta} = \frac{\partial^2 E}{\partial u_i^{\alpha} \partial u_j^{\beta}}|_0$ $D_{i_1,i_2,\cdots,i_n} = \frac{\partial^n E}{\partial u_{i_1} \partial u_{i_2} \cdots \partial u_{i_n}}|_0$

Anharmonic Hamiltonian (center part):

$$H_n = \sum_{n=3,4,\cdots} H^{(n)} = \sum_{n=3,4,\cdots} \frac{1}{n!} \sum_{i_1,i_2,\cdots,i_n} D_{i_1,i_2,\cdots,i_n} u_{i_1} u_{i_2} \cdots u_{i_n}$$

First-principles based NEGF method

Phonon transmission function: $\Xi(\omega) = Tr[\Gamma_{L}(\omega)G^{r}(\omega)\Gamma_{R}(\omega)G^{a}(\omega)]$

 $\Gamma_{\mathrm{L}(\mathrm{R})}(\omega) = i[\Sigma_{\mathrm{L}(\mathrm{R})}^{\mathrm{r}}(\omega) - \Sigma_{\mathrm{L}(\mathrm{R})}^{\mathrm{a}}(\omega)]$

Thermal current and conductance (phonon)

$$I = \int \frac{dk}{2\pi} h \omega \frac{\partial \omega}{\partial k} \Xi(\omega) [f(\omega, T_H) - f(\omega, T_C)]$$
$$\sigma(T) = \frac{h^2}{2\pi k_B T^2} \int_0^\infty d\omega \frac{\omega^2 e^{h\omega/(k_B T)}}{(e^{h\omega/(k_B T)} - 1)^2} \Xi(\omega)$$

 $\begin{array}{c} & & & & \\ & & & & \\ & & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\$

8

6 X 10

12

Quantum thermal conductance: g_0

$$g_0(T) = \frac{\pi^2 k_B^2 T}{3h} = (9.46 \times 10^{-13} \text{ W/K}^{-2})T$$

4

0.2

0.0·

0

2

Non-equilibrium Green's function (NEGF) Method

Thermal transport in nanodevices



Phonon transmission function:

 $\Xi(\omega) = Tr[\Gamma_{\rm L}(\omega)G^{\rm r}(\omega)\Gamma_{\rm R}(\omega)G^{\rm a}(\omega)]$

 $\Gamma_{\rm L}(\omega) = i[\Sigma_{\rm L}^{\rm r}(\omega) - \Sigma_{\rm L}^{\rm a}(\omega)] \qquad \Gamma_{\rm R}(\omega) = i[\Sigma_{\rm R}^{\rm r}(\omega) - \Sigma_{\rm R}^{\rm a}(\omega)]$

First-principles based NEGF approach

Green's function:

$$G_{\rm CC}^{\rm r} = \left[\left(\omega + i\delta \right)^2 - D_{\rm CC} - \Sigma_{\rm L}^{\rm r} - \Sigma_{\rm R}^{\rm r} \right]^{-1}$$

Force constants (FCs):

$$D_{i\alpha,j\beta} = \frac{1}{\sqrt{M_i M_j}} \frac{\partial^2 E}{\partial u_{i\alpha} \partial u_{j\beta}} \Big|_0 = \frac{\Phi_{i\alpha,j\beta}}{\sqrt{M_i M_j}}$$

To calculate FCs:

- 1. Ab inito methods
- 2. Empirical potentials

(Brenner potential for carbon materials, ...)

Thermal conductance (Landauer formula):

$$\sigma(T) = \frac{h^2}{2\pi k_B T^2} \int_0^\infty d\omega \frac{\omega^2 e^{h\omega/(k_B T)}}{\left(e^{h\omega/(k_B T)} - 1\right)^2} \Xi(\omega)$$

NEGF Method

Workflow of NEGF Method (with phonon-phonon interaction)



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- * Graphene nanoribbons
- *** Graphene-based nanoelectronics**

Summary

Nanotube phonon waveguide



SEM images

Thermal conductivity of nanotubes is insensitive to structural deformation.

Phonon waveguide!

C. W. Chang et al., Phys. Rev. Lett. 99, 045901 (2007).

Transport system

What is the underlying physics for nanotube phonon waveguide?



Radial strain: $\eta = d'/d_0$

Phonon scattering occurs at interface



Thermal conductance is insensitive to the length of the confined region.

Radial strain-dependent thermal conductance



Nontrivial linear response, very robust, why?

Radial strain-dependent phonon transmission



- Quasi-ballistic transport at low frequencies.
- Large strain (within elastic regime) can be viewed as a perturbation to the transport low frequency modes.

Effects of tube diameter and chirality



The robust linear response behavior is general in CNTs.

Effects of tube diameter and chirality



Different linear dependence at low and high strains.

Effects of tube diameter and chirality



Larger CNTs have more phonon modes; and thus the same strain causes larger thermal conductance decrease.

Radial strain induced Bond angle change



• The root mean square deviation δ is larger in zigzag CNTs than in armchair CNTs, which explains the weak chirality dependence in thermal conductance.

Conclusion

Thermal conductance shows a universal linear dependence on radial strain over all the elastic range.

Thermal conductance is quite robust against large radial deformation (up to the strain of 70%), indicating that CNTs are perfect phonon waveguides.

 Physical origin: under the elastic deformation, the mechanical properties don't change much.

Graphene nanoribbons: Anisotropy





Q. Yan, et al., Nano Lett. 7, 1469 (2007).

Y. W. Son, et al., Nature 444, 347 (2006).

Model: edge effects

- Width and edge shape of GNRs significantly influence electronic properties.
- Effects on thermal transport properties?
- Critical for developing any practical graphenebased devices.

Armchair GNR

Zigzag GNR





W refers to circumference for CNTs.



Results and Discussion



Thermal conductance is isotropic in graphene.

K. Saito, et al., Phys. Rev. B 76, 115409 (2007).

Results and Discussion

<110> SiNW exhibits σ/S(300 K) 50% and 75% larger than <100> and <111> SiNWs. T. Markussen, *et al.*, Nano Lett. **8**, 3771 (2008).

Anisotropic phonon structure of bulk Si.

What is the origin of anisotropic thermal conductance in GNRs?

Isotropic in graphene and CNTs, but anisotropic in GNRs.

Different boundary condition at edges.

Most phonon modes are influenced by the boundary. This makes the analysis complicated.



Results and Discussion



obvious at 400 ~ 600 cm⁻¹ and 1400 ~ 1650 cm⁻¹.

Conclusion

- Anisotropy: room temperature thermal conductance of ZGNRs is up to ~ 30% larger than that of AGNRs. The anisotropy disappears when W > 100 nm.
- This intrinsic anisotropy originate from different boundary condition at ribbon edges.
- Important implications for the applications of GNRs in nanoelectronics and thermoelectricity.

Graphene-based nanostructures



Two major building blocks:

Graphene junction





Graphene quantum dot



Richard Van Noorden Nature 442, 228 (2009).

Structure & thermal transport

Graphene-based nanodevices



Structural characteristics:

contact geometries, widths, edge shapes, connection angles ...

How do they affect thermal transport?

Red parts: thermal leads

Contact geometry



Thermal transport is *insensitive* to *the detailed structure in the contact region*, quite different from electronic transport.



Width effects





Thermal contact resistance



Interestingly, R_c of double-interface junctions is just slightly higher than that of single-interface junctions.

Phonon LDOS



Graphene junctions in experiments



L. C. Campos, *et al.* Nano Lett. 9, 2600 (2009).

X. Li, *et al*. Science 319, 1229 (2008).

Connection angles: 30°, 60°, 90°, 120°, 150°



Connection angles



Graphene junctions with *smaller connection angles* show *lower thermal conductance* and *higher electronic conductance*.

Graphene QDs



Conclusion

- Thermal conductance is insensitive to the detailed structure of the contact region but substantially limited by the narrowest part (bottleneck!) of the systems.
- Thermal contact resistance R_C in graphene nanodevices is quite low (~ 10⁻¹⁰ m²K/W at 300 K). Interestingly, R_C of double-interface junctions is just slightly higher than that of single-interface junctions.
- Different even opposite dependences of thermal and electronic transport properties on the structural characteristics may find wide applications in nanoelectronics and thermoelectricity.

Summary

- Calculation method for quantum thermal transport is developed.
- CNTs are robust phonon waveguides against radial deformations.
- GNRs exhibits intrinsic anisotropy (up to 30%) which originates from different boundary condition at ribbon edges.
- Thermal conductance is substantially limited by the narrowest part of the systems.
- Low thermal contact resistance in graphene.

Collaborators/students

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Thank You I